

ADVANCED SEMICONDUCTOR ENGINEERING INC
Form 6-K
July 09, 2012

FORM 6-K
SECURITIES AND EXCHANGE COMMISSION
Washington, D.C. 20549

Report of Foreign Private Issuer

Pursuant to Rule 13a-16 or 15d-16
of the Securities Exchange Act of 1934

July 9, 2012

Commission File Number 001-16125

Advanced Semiconductor Engineering, Inc.
(Exact name of Registrant as specified in its charter)

26 Chin Third Road
Nantze Export Processing Zone
Kaoshiung, Taiwan
Republic of China
(Address of principal executive offices)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.

Form 20-F X Form 40-F

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(1):

Note: Regulation S-T Rule 101(b)(1) only permits the submission in paper of a Form 6-K if submitted solely to provide an attached annual report to security holders.

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(7):

Note: Regulation S-T Rule 101(b)(7) only permits the submission in paper of a Form 6-K if submitted to furnish a report or other document that the registrant foreign private issuer must furnish and make public under the laws of the jurisdiction in which the registrant is incorporated, domiciled or legally organized (the registrant's "home country"), or under the rules of the home country exchange on which the registrant's securities are traded, as long as the report or other document is not a press release, is not required to be and has not been distributed to the registrant's security holders, and, if discussing a material event, has already been the subject of a Form 6-K submission or other

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Commission filing on EDGAR.

Indicate by check mark whether by furnishing the information contained in this Form, the registrant is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.

Yes No X

If "Yes" is marked, indicate below the file number assigned to the registrant in connection with Rule 12g3-2(b):
Not applicable

Signatures

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

ADVANCED SEMICONDUCTOR
ENGINEERING, INC.

Date: July 9, 2012

By:

Name:

Title:

/s/ Joseph Tung

Joseph Tung

Chief Financial Officer

MINUTES

OF
2012 ANNUAL SHAREHOLDERS' MEETING
OF
ADVANCED SEMICONDUCTOR ENGINEERING, INC.
(Translation)

1. Time: 10:00 a.m. Thursday, June 21, 2012

2. Place: Zhuang Jing Auditorium, 600 Jiachang Rd., Nantz Export Processing Zone, Nantz District, Kaohsiung City

3. Present: Total shares represented by shareholders and proxy present 5,224,207,624 shares(including exercised by way of electronic transmission 2,102,820,515 shares) is 80.01% of total outstanding shares of ASE 6,529,464,354 shares (excluding the shareholders who had no voting right stipulated in Company Law)

4. Chairperson's Remarks: (To be omitted)

5. Status Reports

- (1) Business Report of 2011. (see Attachment I)
- (2) Report by supervisors on review of the 2011 financial statements. (see Attachment II)
- (3) Report on total amount for endorsement, guarantee and amount of loans to third parties.
 - (4) Report on the Company's secured corporate bonds issued domestically.
 - (5) Report on the implementation of the Company's indirect investments in mainland China.
 - (6) Report on the implementation of buyback of Company shares.
 - (7) Report on the status of the Company's merger with Power ASE Technology.

6. Matters for Ratification

Item 1 (proposed by the Board of Directors)

Proposal: 2011 final accounts for your recognition.

Explanation: 1. The Company's 2011 financial statements have been audited and attested by

Deloitte & Touche and reviewed by the Supervisors.

2. Please ratify the financial statements (see Attachment III of this Agenda Manual for details) and the 2011 Business Report (see Attachment I of this Agenda Manual for details).

Resolution: Voting results: Ratify 4,174,584,087 shares (including exercised by way of electronic transmission 1,238,940,461 shares); Oppose 6,311 shares (including exercised by way of electronic transmission 6,311 shares); Abstain from voting 863,873,743 shares (including exercised by way of electronic transmission 863,873,743 shares). Resolved, that the above proposal be and hereby was approved as proposed.

Item 2 (proposed by the Board of Directors)

Proposal: Please ratify the Company's 2011 proposal for earnings distribution.

Explanation: The Board of Directors has drafted the Company's 2011 proposal for surplus distribution as shown in the table below in accordance with the related regulations and the Company's Articles of Incorporation for your ratification.

Advanced Semiconductor Engineering, Inc.
2011 Surplus Distribution Proposal

Unit: NT\$

Item	Amount
Prior year retained earnings	6,771,511,652
Add: Current year gross profit	13,725,957,896
Add: Reversal of special surplus reserve	1,272,417,273
Subtract: Provision for 10% statutory surplus reserve	1,372,595,790
Current year earnings to be distributed	20,397,291,031
Items for distribution:	
Dividends (Note 1)	13,641,279,185
Current year retained earnings	6,756,011,846

Remark:

NT\$246,000,000 to be distributed for Director and Supervisor remuneration.

NT\$1,235,336,000 to be distributed for employee bonuses, all in cash

President: Jason C.S. Chang

Manager: Richard H.P. Chang

Accountant Manager: Joseph Tung

Note 1:

A total of NT\$13,641,279,185 is distributed as dividends, NT\$2.05 per share, with NT\$4,325,283,645 in cash (a cash dividend of NT\$0.65 per share) and the remaining NT\$9,315,995,540 in stock (140 shares for each 1000 shares retained by converting earnings into capital stock). The above distribution of dividends to shareholders and the cash and stock dividend distribution rates are calculated based on the number 6,654,282,532 of shares recorded in the Register of Shareholders as of March 20, 2012. In the future, if the Company's ECB holders exercise the right of conversion, or new shares are issued to employees against Employee Stock Option warrant, new shares are issued by the Company for a cash capital increase, or there is a buyback of the Company's stocks, or transfer or cancellation of the Company's treasury stocks, which affect the cash distribution rate of the shareholders' bonus, requiring adjustment, the management will request the shareholders' meeting to authorize the Board of Directors to handle the matter and make adjustments accordingly.

Note 2:

In response to the introduction of an integrated income tax system, earnings of the most recent year will be distributed this time.

Resolution:

Voting results: Ratify 4,164,343,390 shares (including exercised by way of electronic transmission 1,239,700,244 shares); Oppose 9,799 shares (including exercised by way of electronic transmission 9,799 shares); Abstain from voting 863,110,472 shares (including exercised by way of electronic transmission 863,110,472 shares). Resolved, that the above proposal be and hereby was approved as proposed.

7. Matters for Discussions

Item 1 (proposed by the Board of Directors)

Proposal: Please consider a share issue by converting earnings into equity stock.

Explanation: 1. To fund a factory expansion project, plans are being made to issue 931,599,554 new shares at a face value of NT\$10 each to raise NT\$9,315,995,540 with dividends of the same amount to be distributed in 2011.

2. Rules governing allotment of new shares: Based on the number of shares recorded in the Company's Register of Shareholders on March 20, 2012,

namely 6,654,282,532, each 1,000 shares are eligible for an allotment of 140 shares for earnings converted into capital stock. If the number of shares eligible for dividend distribution changes as a result of conversion of offshore convertible bonds, exercise of stock options by employees, cash capital increases, buyback of company shares, or assignment or cancelation of treasury stock, shareholders are urged to authorize the board of directors to make corresponding adjustments, if any, to per-share dividends. Shareholders allotted fractions of a share will coordinate among themselves to combine and form whole shares within five days after the ex-dividend date. Share fractions failing to combine will be paid fractions of the face value in cash and the president will be authorized by the board to have them purchased by certain persons.

3. Rights and obligations of newly issued shares are the same as those of existing shares.
4. Ex-dividend date: The board is authorized to set the date after it is passed at the AGM and approved by the regulatory authority.
5. The factory expansion plan financed by the capital increase is expected to be completed by December 2015. Implementation of the plan is expected to boost the Company's competitiveness, improve its efficiency, and have a positive impact on shareholders' rights and interests. The board is authorized to make necessary changes if the capital increase must be changed as ordered by the regulatory authority or required by circumstances.

Resolution: Voting results: Ratify 4,149,570,076 shares (including exercised by way of electronic transmission 1,224,926,930 shares); Oppose 14,784,578 shares (including exercised by way of electronic transmission 14,784,578 shares); Abstain from voting 863,109,007 shares (including exercised by way of electronic transmission 863,109,007 shares). Resolved, that the above proposal be and hereby was approved as proposed.

Item 2 (proposed by the Board of Directors)

Proposal: The Company's overseas private placement of convertible bonds

Explanation: 1. In support of the long-term capital requirements for the Company's strategic development, the shareholders' meeting is requested to authorize the Board of Directors to conduct overseas private placement of convertible bonds (hereinafter referred to simply as "convertible bonds") at the appropriate time and in accordance with the Company's capital requirements at the time, financial market conditions or regulatory requirements within the following time limit in order to raise the required long-term funding: within one year following the resolution is passed at the shareholders' meeting. The Company may select the private placement overseas unsecured convertible bonds or subordinated convertible perpetuities, or a combination of both. However, the maximum amount of the privately placed convertible bonds shall be NT\$9 billion. The tentative issuance and conversion policy of the current private placement of convertible bonds for unsecured convertible, please refer to Attachments IV and subordinated convertible perpetuities, please refer to Attachment V.

2. Basis and rationality for pricing privately placed securities

The pricing for the Company's privately placed convertible bonds shall be based on no less than 80% of the theoretical price referred to in the "Directions for Public Companies Conducting Private Placements of Securities." To determine the actual issue price, the shareholders' meeting is requested to authorize the Board of Directors to proceed in accordance to applicable laws, the pricing basis and range of percentage specified by the resolution reached at the shareholders' meeting, the prevailing market conditions and the Company's situation. The pricing of the current privately placed convertible bonds is based on the regulatory requirements of the competent authority. In consideration of the fact that the timing for the transfer of ownership of privately placed securities, parties to whom the securities are transferred and the quantity of transfer are all strictly regulated, as well as factors such as the securities may not be listed on the exchange for three years and their lower liquidity, the conditions laid down for the current private placement of corporate bonds are therefore quite reasonable.

3. Selection and purpose of subscribers, necessity and expected benefits

The selection of subscribers shall be carried out pursuant to Article 43-6 of the Securities and Exchange Act and the provisions of the order Tai-Tsai-1 No. 0910003455 issued by the original Securities and Futures Commission of the Ministry of Finance dated June 13, 2002. The purpose of the selection of subscribers in the current placement is the recruitment of strategic investors. The so-called "strategic investors" referred to here are individuals or corporate entities capable of improving the Company's profitability with their experience, technologies, knowledge, brands or channels via industrial vertical and horizontal integration or joint research and development of products and markets, which will help the Company achieve benefits such as enhanced technology, improved quality, reduced costs, increased efficiency and expanded markets. The selection of subscribers is carried out by the Board of Directors on authority of the shareholders' meeting. The purpose, necessity and expected benefits lie with accommodating the Company's business development requirements, and it is proposed that through private placement the investors will be able to help the Company to enhance its technology, improve quality, reduce costs, increase efficiency and expand markets, so as to raise the Company's competitiveness and enhance its operating performance and long-term development capabilities.

4. Necessity for private placement, utilization of capital and expected benefits

(1) Rationality for not adopting the public offer approach:

To accommodate the Company's future business development and to attract strategic investors; taking into consideration the timeliness, convenience, issuance costs and stability of ownership structure associated with private placements, along with the restrictions that ownership of the securities may not be transferred within three years, private placement ensures the long-term partnership of the Company with the strategic investors, and as a result private placement is adopted.

(2) Maximum amount raised via private placement:

Privately placed convertible bonds are subject to a maximum amount of

NT\$9 billion. However, the actual amount that can be raised is subject to applicable laws at the time the placement is made, the conditions of the financial market and approval of the competent authority. In the event that the holders of the convertible bonds obtain the Company's common shares by exercising the conversion rights, the number of shares thus obtained shall be determined by the conversion price at the time of the conversion.

(3) Utilization of capital and expected benefits:

The current private placement of securities may be carried out by the Board of Directors on authorization of the shareholders' meeting within one year of the passage of the resolution. The amount of capital raised is expected to be used for one or more of the following purposes: capital expenditure, increasing the working capital, repaying bank loans and reinvestment. It is also expected that all the capital will be utilized within three years of the private placement. The expected benefits are one or more of the following: strengthening of the Company's position within the industry, raising long-term competitiveness, improving the financial structure and achieving savings in interest expenses. These will produce a positive impact on the shareholders' equity. However, the actual placement process and capital utilization schedule will depend on the Company's capital requirements, regulations and the conditions of the financial market .

5. Rights and obligations associated with the conversion of the convertible bonds into common shares

With respect to the common shares obtained from the conversion of convertible bonds from the current private placement, the associated rights and obligations are identical to those of the common shares issued by the Company. However, the listing and resale of these shares shall be governed by the relevant provisions of the Securities and Exchange Act. In the case of privately placed overseas convertible bonds, the provisions of the official letter FSC-Zheng-1 No. 09700513881, dated October 21, 2008 and issued by the Financial Supervisory Commission, Executive Yuan shall apply.

6. The main provisions of the current private placement include the issuance and conversion policies, actual privately placed price, private placement conditions, project items, amount, expected progress schedule, potential benefits and other matters associated with the issuance plan. The shareholders' meeting is asked to approve the private placement plan and authorize the Board of Directors to carry out the plan at its discretion and make adjustments in accordance with the Company's financial requirements, conditions in the financial market and relevant laws and regulations. The shareholders' meeting is also asked to authorize the Board of Directors to proceed at its discretion with any necessary modifications or adjustments to the plan in the event of regulatory changes, instructions from the competent authority, changes in the market, operational assessment or other objective environmental factors.
7. To accommodate the follow-up operations associated with the private placement of convertible bonds, the shareholders' meeting is asked to authorize the Chairman of the Board or his designee to enter into all relevant contracts and documents on behalf of the Company and to handle all subsequent actions that are required.
8. For matters that are not covered herein, the shareholders' meeting is asked to authorize the Board of Directors to proceed at its discretion and in accordance with the law.

Resolution: Voting results: Ratify 4,051,894,971 shares (including exercised by way of electronic transmission 1,140,104,591 shares); Oppose 91,661,851 shares (including exercised by way of electronic transmission 91,661,851 shares); Abstain from voting 871,054,073 shares (including exercised by way of electronic transmission 871,054,073 shares). Resolved, that the above proposal be and hereby was approved as proposed.

Item 3 (proposed by the Board of Directors)

Proposal: Please consider the revision of the Company's Guidelines for the Acquisition or Disposal of Assets.

- Explanation: 1. In compliance with the Regulations Governing the Acquisition and Disposal of Assets by Public Companies, amended and promulgated by the Financial Supervisory Commission, Executive Yuan on February 13, 2012, the Board of Directors has approved the revisions of portions of the Company's Guidelines for the Acquisition or Disposal of Assets on March 29, 2012.
2. Please refer to Attachment IV to this Agenda Manual for the table of comparison of the Company's revised Guidelines for the Acquisition or Disposal of Assets. Your consent is solicited.
- Resolution: Voting results: Ratify 4,164,157,783 shares (including exercised by way of electronic transmission 1,239,692,637 shares); Oppose 17,067 shares (including exercised by way of electronic transmission 17,067 shares); Abstain from voting 863,110,811 shares (including exercised by way of electronic transmission 863,110,811 shares). Resolved, that the above proposal be and hereby was approved as proposed.

Item 4 (proposed by the Board of Directors)

Proposal: Please consider the revision of the Company's Rules Governing the Election of Directors and Supervisors.

- Explanation: 1. In compliance with the electronic voting regulations introduced by the competent authority, the Board of Directors has approved the revisions of portions of the Company's Rules Governing the Election of Directors and Supervisors on March 29, 2012.
2. Please refer to Attachment V of this Agenda Manual for the table of comparison of the Company's revised Rules Governing the Election of Directors and Supervisors. Your consent is solicited.
- Resolution: Voting results: Ratify 4,164,335,783 shares (including exercised by way of electronic transmission 1,239,692,637 shares); Oppose 17,067 shares (including exercised by way of electronic transmission 17,067 shares); Abstain from voting 863,110,811 shares (including exercised by way of electronic transmission 863,110,811 shares). Resolved, that the above proposal be and hereby was approved as proposed.

Item 5 (proposed by the Board of Directors)

Proposal: Please consider the revision of the Company's Rules of Procedure for the Shareholders' Meeting.

- Explanation: 1. In compliance with the regulations introduced by the competent authority restricting the use of electronic voting, the Board of Directors has approved the revisions of portions of the Company's Rules of Procedure for the Shareholders' Meeting on March 29, 2012.
2. Please refer to Attachment VI to this Agenda Manual for the table of comparison of the Company's revised Rules of Procedure for the Shareholders' Meeting. Your consent is solicited.

Resolution: Voting results: Ratify 4,164,335,782 shares (including exercised by way of electronic transmission 1,239,692,636 shares); Oppose 17,068 shares (including exercised by way of electronic transmission 17,068 shares); Abstain from voting 863,110,811 shares (including exercised by way of electronic transmission 863,110,811 shares). Resolved, that the above proposal be and hereby was approved as proposed.

Item 6 (proposed by the Board of Directors)

Proposal: Please discuss the revised version of the Company's Articles of Incorporation.

- Explanation: 1. In order to allow the Company's independent directors to serve as members of the Remuneration Committee, their salaries and compensation should be taken into consideration in a comprehensive manner. Revisions to portions of the Company's Articles of Incorporation have been approved at the Board of Directors meeting held on March 29, 2012.
2. Please refer to Attachment VII to this Agenda Manual for the table of comparison of the Company's revised Articles of Incorporation. Your consent is solicited.

Resolution: Voting results: Ratify 4,164,335,815 shares (including exercised by way of electronic transmission 1,239,692,669 shares); Oppose 17,035 shares (including exercised by way of electronic transmission 17,035 shares); Abstain from voting 863,110,811 shares (including exercised by way of electronic transmission 863,110,811 shares). Resolved, that the above proposal be and hereby was approved as proposed.

8. Matters for Elections

Item 1 (proposed by the Board of Directors)

Proposal: Re-election of the Company's directors and supervisors upon the expiration of their term of office.

Explanation: 1. The terms of the Company's nine directors (including two independent directors and seven non-independent directors) and five supervisors will expire on June 25, 2012, and new directors and supervisors are to be elected as required by the law. The term of the new directors and supervisors shall be the period of three years from June 22, 2012 to June 21, 2015.

2. The list of candidates for independent directorship and their corresponding background information are as follows.

Candidate for Independent Director	Education	Experience	Number of shares held
Shen-Fu Yu	Accounting Program, Department of Business Administration, National Taiwan University	Supervisor of the Company and member of the Company's Remuneration Committee Supervisor, DynaPack Corp.	0 shares
	MA, Dept. of Accounting, National Chengchi University	Supervisor, Arima Optoelectronics Corp. Supervisor, Arima Lasers Corp. Remuneration Committee, Yulon Motor Co., Ltd. Remuneration Committee, Taiwan Acceptance Corporation Remuneration Committee, Kian Shen Corporation Remuneration Committee, Elite Material Co., Ltd.	

Adjunct Instructor, National
Taipei College of Business

Certified Public
Accountant, Deloitte &
Touche (retired)

Ta-Lin Hsu BS in Physics, National Supervisor of the Company 0 shares
 Taiwan University and member of the
 MS in Electrophysics, Company's Remuneration
 Polytechnic Institute of Committee
 New York University Chairman & Founder, H&Q
 (Brooklyn Campus) Asia Pacific
 Ph.D. in Electrical General Partner, Hambrecht
 Engineering, & Quist Group, U.S.A.
 University of
 California, Berkeley

Election results: List of elected directors and supervisors:

No. / ID No.	Name	Votes received	Note
1	A.S.E. Enterprises Limited representative Jason C.S. Chang	4,020,151,026	Director
3	Richard H.P. Chang	3,913,552,850	Director
1	A.S.E. Enterprises Limited representative Tien Wu	3,850,148,326	Director
1	A.S.E. Enterprises Limited representative Joseph Tung	3,806,954,674	Director
654960	J&R Holding Limited representative Raymond Lo	3,763,920,006	Director
654960	J&R Holding Limited representative Jeffrey Chen	3,752,693,844	Director
372564	Rutherford Chang	3,732,323,988	Director
H101****17	Shen-Fu Yu	3,720,355,046	Independent Director
1943****HS	Ta-Lin Hsu	3,720,120,460	Independent Director

No.	Name	Votes received	Note
61233	Hung Ching Development & Construction Co. representative Yen-Yi Tseng	3,759,404,304	Supervisor
61233	Hung Ching Development & Construction Co. representative David Pan	3,569,076,478	Supervisor
61233	Hung Ching Development & Construction Co. representative Tien-Szu Chen	3,466,467,364	Supervisor
61233	Hung Ching Development & Construction Co. representative Chun-Che Lee	3,454,168,523	Supervisor
61233	Jerry Chang	3,367,199,469	Supervisor

9. Other Resolutions

Item 1 (proposed by the Board of Directors)

Proposal: Proposal to waive the non-competition clauses applicable to newly elected directors.

- Explanation: 1. Pursuant to Article 209 of the Company Act, a director who carries out actions for himself/herself or on behalf of another person in a manner that is within the scope of the Company's business shall explain to the meeting of shareholders the nature and content of such actions and secure its approval.
2. If, following re-election, new directors are engaged in the investment or operation of a business entity whose scope of business is similar to that of the Company and acts as a director thereof, we request that the non-competition clauses applicable to the director be waived in order to allow him or her to act as a director or the representative of said business entity, provided that such waiver will not infringe upon the interests of the Company.

Other positions held by newly elected Directors are presented below

Name	Other Positions
Jason C.S. Chang	J&R Industrial Inc. -Director ASE Japan Co., Ltd.-Director ASE Test Inc. -Director ASE Test Holding, Ltd.-Director ASE (Korea) Inc.-Director ISE Labs, Inc.-Director ASE Holding Ltd.(Bermuda)-Director J&R Holding Ltd.(Bermuda)-Director Innosource Ltd.-Director ASE (Kunshan), Inc. -Director ASE Test Limited (Singapore)-Director ASE (Shanghai) Inc. -Director ASE Module (Shanghai) Inc. -Director ASE Hi-Tech (Shanghai) Inc. -Director ASE Electronics Inc.-Director ASE Mauritius Inc.-Director

ASE Corporation -Director
Suzhou ASEN Semiconductors Co., Ltd. -Director
ASE Module (Kunshan) Inc. -Director
ASE Labuan Inc.-Director
Advanced Semiconductor Engineering(China) Ltd. -Director
ASE Singapore Pte. Ltd.-Director
Alto Enterprises Ltd.-Director
Super Zone Holdings Ltd.-Director
Anstock Limited -Director
Universal Scientific Industrial (Shanghai) Co., Ltd.-Director
Universal Global Technology (Shenzhen) Co., Ltd.-Director
Universal Scientific Industrial Co., Ltd. - Director

Richard H.P. J&R Industrial Inc.-Director
Chang Innosource Ltd.-Director
ASE(Shanghai) Inc. -Director
ASE Test Inc.-Director
Omniquest Industrial Ltd.-Director
ASE Test Limited (Singapore) -Director
ASE (Korea) Inc.-Director
ASE Electronics (Malaysia) Sdn., Bhd.-Director
ASE Holding Ltd. (Bermuda) -Director
J&R Holding Ltd.(Bermuda) -Director
ASE (Kunshan), Inc. -Director
ASE Module(Shanghai) Inc. -Director
ASE Hi-Tech(Shanghai) Inc. -Director
Global Advanced Packaging Technology Ltd. (Cayman)-Director
ASE Assembly & Test (Shanghai) Ltd. -Director
ASE Assembly & Test (HK) Ltd.-Director
ASE Module (Kunshan) Inc. -Director
ASE Japan Co., Ltd.-Director
Advanced Semiconductor Engineering (HK) Limited -Director
Advanced Semiconductor Engineering(China) Ltd. -Director
Alto Enterprises Ltd.-Director
Super Zone Holdings Ltd.-Director
Anstock Limited -Director
Real Tech Holdings Limited -Director
Universal Scientific Industrial (Shanghai) Co., Ltd.-Director
Universal Scientific Industrial (Kunshan) Co., Ltd.-Director
USI Electronics (Shenzhen) Co., Ltd.-Director
Universal Global Technology Co., Limited-Director

Universal Global Technology (Shenzhen) Co., Ltd.-Director
Universal Global Industrial Co., Limited-Director
Universal Global Scientific Industrial Co., Ltd.-Director
USI Enterprise Limited-Director
Universal Global Technology (Kunshan) Co., Ltd. -Director
Universal Scientific Industrial Co., Ltd. - Director

Tien Wu ISE Labs, Inc.-Director
ASE Japan Co., Ltd.-Director
ASE Marketing & Service Japan Co., Ltd.-Director
Global Advanced Packaging Technology Ltd. (Cayman)-Director
ASE Assembly & Test (Shanghai) Ltd. -Director & General Manager
ASE Assembly & Test(HK) Ltd.-Director
Suzhou ASEN Semiconductors Co., Ltd. -Director
ASE (Weihai) Inc. -Director
ASE (U.S.) Inc.-General Manager

Joseph Tung J&R Industrial Inc.-Director
ASE Japan Co., Ltd.-Supervisor
ASE Test Inc.-Supervisor
ASE Marketing & Service Japan Co., Ltd.-Supervisor
Innosource Ltd. -Director
J&R Holding Ltd. (Bermuda) -Director
ASE Investment (Labuan) Inc.-Director
ASE Holding Ltd. (Bermuda) -Director
Omniquest Industrial Ltd.-Director
ASE Test Holding, Ltd.-Director
ASE Test Finance, Ltd.-Director
ASE (Korea) Inc.-Director
ASE Electronics (Malaysia) Sdn. Bhd.-Director
ISE Labs, Inc.-Director
ASE Mauritius Inc.-Director
ASE Electronics Inc.-Director
ASE Module (Kunshan) Inc. -Supervisor
ASE Labuan Inc. -Director
ASE Corporation-Director
Alto Enterprises Ltd.-Director
Anstock Limited -Director
Universal Scientific Industrial Co., Ltd.-Supervisor
Universal Scientific Industrial (Shanghai) Co., Ltd.-Supervisor
Universal Global Scientific Industrial Co., Ltd.-Supervisor

Lu-Chu Development Corporation-Supervisor
H.R. Silvine – CMC Company (Hong Kong)-Director
Ta Chong Bank-Independent Director

Raymond Lo ASE Test Inc.-Director & General Manager

Jeffrey Chen ASE Test Inc.-Director
ASE(Kunshan), Inc. -Director
ASE Test Limited(Singapore)-Director
ASE Test Holdings Ltd.-Director
Omniquest Industrial Ltd.-Director
ISE Labs, Inc.-Director
ASE Investment (Labuan) Inc.-Director
ASE Module(Shanghai) Inc -Director
ASE Hi-Tech(Shanghai) Inc. -Director
Shainghai Ding Hui Real Estate Development Co., Ltd. -Director
ASE Electronics Inc.-Director
Advanced Semiconductor Engineering (HK) Limited -Director
ASE Module (Kunshan) Inc. -Director
Suzhou ASEN Semiconductors Co., Ltd. -Director
Shainghai Ding Wei Real Estate Development Co., Ltd. -Director
Shainghai Ding Yu Real Estate Development Co., Ltd. -Director
Super Zone Holdings Ltd.-Director
Universal Scientific Industrial Co., Ltd. - Director
Senetex Investment Co., Ltd.-Director
Ta-Chi Investment Co., Ltd.-Director
Huntington Holdings International Co. Ltd.-Director
United Investments Company - Director

Rutherford ASE(Shanghai) Inc. -Director
Chang Advanced Semiconductor Engineering(China) Ltd. -Director
Universal Scientific Industrial (Shanghai) Co., Ltd.-Director
ASE Test Inc.-Director
ASE Assembly & Test (Shanghai) Ltd. -Director

Shen-Fu Yu DynaPack Corp.-Supervisor
Arima Optoelectornics Corp. - Supervisor
Arima Lasers Corps. - Supervisor

Ta-Lin Hsu Chairman and founder, H&Q Asia Pacific

Resolution: Voting results: Ratify 4,013,606,881 shares (including exercised by way of electronic transmission 1,108,266,128 shares); Oppose 129,715,365 shares (including exercised by way of electronic transmission 116,659,808 shares); Abstain from voting 877,894,579 shares (including exercised by way of electronic transmission 877,894,579 shares). Resolved, that the above proposal be and hereby was approved as proposed.

10. Extempore Motions: None

11. Meeting Ended: Thursday, June 21, 2012 at 11:55 a.m.

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Advanced Semiconductor Engineering, Inc.
Business Report

Compared with the strong recovery of the global economy in 2010, 2011 was a comparatively slow year of economic growth, and the electronics industry overall declined by a slight margin. According to statistics compiled by World Semiconductor Trade Statistics (WSTS), global semiconductor sales grew by only 0.4% in 2011. The IEK ITIS project of the Industrial Technology Research Institute (ITRI) also reported that the production output of Taiwan's semiconductor industry for 2011 was NT\$1 trillion 555.8 billion, a decline of about 11.3% compared with the preceding year. In the IC assembly and testing industry, weak global demand, the significant impact of the Japanese earthquake on the packaging materials supply chain and volatile gold prices resulted in the assembly industry's production output of NT\$269.6 billion, a 6.1% decline compared with 2010. The testing industry's output was NT\$120.8 billion, a 5.5% decrease over 2010. Looking back on 2011, the earthquake that greatly damaged Japan's economy and the European debt crisis triggering the downgrades of national credit ratings; the issues of the debt ceiling and the high US unemployment rate, were all factors that contributed to a decline in overall demand and confidence in the market. They also caused the Company to proceed in a more cautious and discreet manner in its business operations. The following is our report on the company's operations for the past year:

"2011 Operating Results"

1. Implementation results for the 2011 business plan

The Company's combined revenues for 2011 were NT\$185.3 billion, a decrease of NT\$3.4 billion over 2010, or a 2% decline. The Company's revenue in 2011 was NT\$127.6 billion for semiconductor assembly and testing services, a growth of 2%. To enhance the level of integration with our subsidiary Power ASE Technology in the areas of resources, manpower and technology, the Company acquired the shares of Power ASE Technology on the open market in the second half of 2011, thus completing the acquisition process. Adjustment of the Group's overall product mix was done in order to phase out weaker products while retaining competitive ones in response to a reversal in the economic climate. In addition, the Company has endeavored to expand its production bases to increase capacity on both sides of the Taiwan Strait. We have begun the construction of the new ASE Shanghai Headquarters building in Pudong with the latest green building technology, which will enhance the Company's technological capabilities and give access to a wealth of talent in China. In Taiwan, two new factory buildings and an office building are being planned for the Company's Chungli plant. In addition, after our Kaohsiung K12 plant is complete, it will be the first assembly and testing plant to receive the Taiwan Green Building Diamond Certification and the LEED Gold Certification from the U.S. Green Building Council.

2. Budget performance

No financial forecast was disclosed in 2011.

3. Analysis of financial accounts and profitability

As of the end of 2011, the Company's paid-in capital was NT\$67,535,632 thousands and shareholders' equity was NT\$101,169,536 thousands accounting for 59% of total assets of NT\$171,078,607 thousands. Its long-term funds are 309% of fixed assets and current ratio is 55%. This year's ratios are slightly lower than the preceding year, but the Company's financial structure and ability to repay debts remain relatively sound. This year's operating profit was NT\$10,859,132 thousands, an increase of NT\$497,929 thousands over the preceding year, which indicates that the Company's core business has grown moderately by 5%. On the other hand, after-tax net profits were NT\$13,725,958 thousands, a decline of 25% compared with the previous year. In terms of overall business operation, the turnover was on par with that of the preceding year, but due to rising gold prices and a stronger New Taiwan dollar, profits were lower than expected. Compared with the results of 2010, there is room for improvement.

4. R&D overview

The semiconductor industry is facing two major challenges: due to the gradual slowdown of the Moore's law, IC process shrinking on the front-end has caused advanced system-on-chip (SoC) integration to slow and the trend of commoditization of consumer electronics products. To respond to the general trends of the overall market, the direction of the Company's R&D strategies for new product and technology development should strike a balance between the two main focuses: "applying system in package (SiP) performance to compensate for the limitations of SoC" and "cost effectiveness." New technologies successfully developed by the Company in 2011 are categorized as follows: (1) For flip-chip assembly, 28 nano copper process / lead-free FCBGA/FCCSP packaging and wire-bond assembly of wafers with an ultra-low dielectric coefficient. (2) For wire-bond assembly, 28 nano copper / gold wire-bond assembly of wafers with an ultra-low dielectric coefficient, 40 nano copper / copper wire-bond assembly of wafers with an ultra-low dielectric coefficient. (3) On the 3D system assembly front, reliability certification was secured for 200mm 28-nm 3D wafer through silicon wafer (TSV) and 3D TSV Stacking Package Level, RF wireless communications (WiFi/BT/GPS/PA) module technology, and MEMS integration assembly. (4) For wafer assembly, 200 mm fan out WLP and 40 μ m Pitch Cu Pillar Bump. The Company will endeavor to continue ASE's advanced fine pitch bump and assembly technology and to maintain its position as the global leader in semiconductor assembly and testing. (5) In addition to achieving R&D results in the field of advanced assembly technology, we have also taken Green Package specifications and elements of Eco-design into consideration in our product and technology development strategies. In the future we will continue to uphold our principles of sustainable R&D and to work closely and diligently with our customers and business partners to achieve technological innovations while minimizing the risks and impact to the environment.

"Outline of 2012 Business Plan"

1. Operating policy

- (1) Providing customer service of the highest quality

(2)creating long-term, stable profits for the Company and its customers.

(3)Working with partner firms to jointly create a prosperous future (4) being as flexible as possible in our business dealings.

2. Projects sales volume and references

In light of current industry dynamics, future market demand and ASE's capacity, the projected sales volume for 2012 is as follows:

Item	Projected Sales
Assembly	Approx. 12.1 billion chips
Test	Approx. 1.5 billion chips

3. Important production and sales policies

In terms of product strategy, the Company will continue to focus on the development of three major assembly processes, including copper wire bonding process, advanced assembly process and low pin count (discrete components) assembly. With respect to our long-term vision, the Company will endeavor to improve the revenue on the integrated device manufacturer (IDM) front, especially in the area of IDM copper wire bonding. In 2011 the revenue from IDM copper wire bonding accounted for only 8.3% of overall copper wire bonding revenue, and there remains significant room for improvement. It is expected that the revenue for IDM will experience vigorous growth in 2012. With portable electronic devices such as smartphones and tablet PCs becoming increasingly popular, semiconductor demand is now focused on miniaturization, high integration, high efficiency, low cost and reduced power consumption. The advent of multifunction integrated chips will present tremendous opportunities for the system assembly industry. The Company will continue to work closely with upstream and downstream vendors in the semiconductor supply chain as well as with customers to realize the considerable systems integration opportunities.

"Development Strategy"

According to projections made by ITRI's IEK ITIS Project, Taiwan's semiconductor industry will grow by 6.5% in 2012. The assembly and testing sectors are estimated to grow at about 7.6% and 7.4%, respectively. Given the unstable global economy, it is necessary to make additional investments and rely on talent and innovation, reduce the cost of copper processes and enhance the quality of assembly and testing so as to improve our market shares in these two areas. The opening up of the Chinese market not only symbolizes the rise of the home market and the large concentration of high-tech talent in China but also the ability of the Company to acquire the professional expertise necessary for its continued growth. In addition, it will help realize the Company's strategies of growing into a major enterprise and expanding market share. Investing in both mainland China and Taiwan has long been the Company's development strategy. The markets of Taiwan and China have a complementary and not an adversarial relationship. We will expand our market share by utilizing the Company's technological, cost and integration advantages as well as continuing to expand our production lines. Another issue that enterprises must address is

the environment. As global awareness of environmental protection has taken hold and is unlikely to be reversed, corporations must actively tackle environmental issues head on and come up with workable solutions.

"Impacts of Competition, Legislation and Operating Environment"

Looking toward 2012, optimism is tempered with a hint of conservatism. The European debt crisis is expected to be alleviated gradually, and the greater affordability of smartphones and other mobile electronic products will spur another wave of growth for the semiconductor industry. Also, the inventory reduction of manufacturers is almost complete. However, problems associated with inflation, unemployment, rising gold prices and exchange rates remain significant concerns in the overall business landscape. Regardless of the changes in the external economic landscape, we hope to achieve growth by relying more on conditions that we create for ourselves rather than solely on the global economic environment. We also hope to enhance our corporate competitiveness to overcome various obstacles and difficulties and to create maximum benefits for our shareholders as well as to maintain the Company's long-term viability and growth.

President: Jason C.S. Chang

President: Richard H.P. Chang

Accountant Manager: Joseph Tung

Supervisors' Report

We have examined the Company's 2011 financial statements, and the Company's business report, earnings distribution proposals, etc. that have been prepared and submitted by the Board of Directors and audited and attested by certified public accountants, Kung Chun Chi and Chiu Hui Yin of Deloitte & Touche, and do not find any discrepancy. We hereby respectfully prepare and present this Report in accordance with Article 219 of The Company Act for your review.

Advanced Semiconductor Engineering, Inc.

AdvancedSemiconductor Engineering, Inc.

Supervisors: YY Tseng
 John Ho
 Sam Liu
 TS Chen
 Jerry Chang

April 16, 2012

Advanced Semiconductor Engineering, Inc.

Financial Statements for the
Years Ended December 31, 2011 and 2010 and
Independent Auditors' Report

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INDEPENDENT AUDITORS' REPORT

The Board of Directors and Shareholders
Advanced Semiconductor Engineering, Inc.

We have audited the accompanying balance sheets of Advanced Semiconductor Engineering, Inc. (the "Company") as of December 31, 2011 and 2010, and the related statements of income, changes in shareholders' equity and cash flows for the years then ended. These financial statements are the responsibility of the Company's management. Our responsibility is to express an opinion on these financial statements based on our audits.

We conducted our audits in accordance with the Rules Governing the Audit of Financial Statements by Certified Public Accountants and auditing standards generally accepted in the Republic of China. Those rules and standards require that we plan and perform the audit to obtain reasonable assurance about whether the financial statements are free of material misstatement. An audit includes examining, on a test basis, evidence supporting the amounts and disclosures in the financial statements, assessing the accounting principles used and significant estimates made by management, as well as evaluating the overall financial statement presentation. We believe that our audits provide a reasonable basis for our opinion.

In our opinion, the financial statements referred to above present fairly, in all material respects, the financial position of the Company as of December 31, 2011 and 2010, and the results of its operations and its cash flows for the years then ended, in conformity with the Guidelines Governing the Preparation of Financial Reports by Securities Issuers, the requirements of the Business Accounting Law and Guidelines Governing Business Accounting relevant to financial accounting standards, and accounting principles generally accepted in the Republic of China.

As discussed in Note 10 to the accompanying financial statements, the Company and its subsidiaries completed the tender offerings for the common shares of Universal Scientific Industrial Co., Ltd. ("USI") in February and August 2010, respectively. Upon the completion of the tender offerings, USI has become a subsidiary of the Company.

We have also audited the consolidated financial statements of the Company and its subsidiaries as of and for the years ended December 31, 2011 and 2010, and have issued an unqualified opinion, and a modified unqualified opinion with an explanatory paragraph, respectively.

March 13, 2012

Notice to Readers

The accompanying financial statements are intended only to present the financial position, results of operations and cash flows in accordance with accounting principles and practices generally accepted in the Republic of China and not those of any other jurisdictions. The standards, procedures and practices to audit such financial statements are those generally accepted and applied in the Republic of China.

For the convenience of readers, the auditors' report and the accompanying financial statements have been translated into English from the original Chinese version prepared and used in the Republic of China. If there is any conflict between the English version and the original Chinese version or any difference in the interpretation of the two versions, the Chinese-language auditors' report and financial statements shall prevail.

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ADVANCED SEMICONDUCTOR ENGINEERING, INC.

BALANCE SHEETS

DECEMBER 31, 2011 AND 2010

(In Thousands of New Taiwan Dollars, Except Par Value)

ASSETS	2011		2010		LIABILITIES AND SHAREHOLDERS' EQUITY	2011		2010	
	Amount	%	Amount	%		Amount	%	Amount	%
CURRENT ASSETS					CURRENT LIABILITIES				
Cash	\$1,475,629	1	\$1,632,102	1	Short-term borrowings	\$302,750	-	\$-	-
Financial assets at fair value through profit or loss - current	471,383	-	72,586	-	Financial liabilities at fair value through profit or loss - current	56,514	-	488,769	-
Available-for-sale financial assets - current	20,152	-	-	-	Hedging derivative liabilities - current	-	-	457,494	-
Accounts receivable, net	9,729,994	6	9,587,062	6	Accounts payable	6,231,424	4	6,231,596	4
Accounts receivable from related parties	62,371	-	99,534	-	Accounts payable to related parties	878,306	-	1,090,674	-
Other receivables	811,196	1	714,388	-	Income tax payable	944,631	-	744,222	-
Other receivables from related parties	305,919	-	1,080,395	1	Accrued expenses	4,700,158	3	4,287,655	3
Inventories	3,292,068	2	2,910,324	2	Other payables to related parties	14,632,851	9	9,348,575	6
Deferred income tax assets - current	691,776	-	461,417	-	Payable for properties	2,747,285	2	1,244,836	-
Other current assets	286,629	-	194,779	-	Other payables	442,414	-	383,581	-
					Current portion of capital lease obligations	199	-	1,504	-
Total current assets	17,147,117	10	16,752,587	10	Other current liabilities	222,639	-	164,547	-
					Total current liabilities	31,159,171	18	24,443,453	15
LONG-TERM INVESTMENTS					LONG-TERM LIABILITIES				
Available-for-sale financial assets - noncurrent	4,675	-	102,790	-					
Financial assets carried at cost - noncurrent	380,680	-	364,551	-					

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Equity method investments	106,233,823	62	101,116,457	63	Hedging derivative liabilities - noncurrent	58,279	-	159,279	-
Total long-term investments	106,619,178	62	101,583,798	63	Bonds payable	7,783,910	5	-	-
					Long-term bank loans	29,611,312	17	47,214,226	2
					Capital lease obligations	-	-	238	-
PROPERTY, PLANT AND EQUIPMENT									
Cost					Total long-term liabilities	37,453,501	22	47,373,743	2
Land	1,558,201	1	1,558,201	1					
Buildings and improvements	21,964,804	13	20,100,741	12	OTHER LIABILITIES				
Machinery and equipment	71,586,364	42	63,587,917	39	Accrued pension cost	1,295,041	1	1,251,957	1
Transportation equipment	68,522	-	63,102	-	Guarantee deposits received	1,358	-	938	-
Furniture and fixtures	876,756	-	846,113	1					
Leased assets	1,351	-	17,221	-	Total other liabilities	1,296,399	1	1,252,895	1
Total cost	96,055,998	56	86,173,295	53					
Less: Accumulated depreciation	54,635,664	32	49,468,469	30	Total liabilities	69,909,071	41	73,070,091	4
Accumulated impairment	44,146	-	64,072	-					
	41,376,188	24	36,640,754	23	CAPITAL STOCK				
Construction in progress	765,382	-	465,003	-	Common Stock - at par value of NT\$10 each				
Machinery in transit and prepayments	2,755,995	2	1,703,819	1	Authorized - 9,500,000 thousand shares and 8,000,000 thousand shares as of December 31, 2011 and 2010,				
Total property, plant and equipment	44,897,565	26	38,809,576	24	respectively			-	-
					Issued - 6,753,563 thousand shares and 6,051,987 thousand shares as of December 31, 2011 and 2010,				
					respectively	67,535,632	40	60,519,872	3
INTANGIBLE ASSETS					Capital received in advance	35,693	-	299,698	-
Patents	28,981	-	42,831	-					

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Goodwill	957,167	1	957,167	1				
Deferred pension cost	37,655	-	44,024	-	Total capital stock	67,571,325	40	60,819,570
Total intangible assets	1,023,803	1	1,044,022	1	CAPITAL SURPLUS			
					Capital in excess of par value	1,615,449	1	1,197,845
OTHER ASSETS					Treasury stock transactions	1,402,632	1	2,136,353
Assets leased to others	661,672	1	1,806,424	1	Long-term investments	3,522,280	2	3,527,240
Idle assets	4,744	-	4,744	-	Employee stock options	857,120	-	319,147
Guarantee deposits	15,147	-	12,950	-	Total capital surplus	7,397,481	4	7,180,585
Deferred charges	499,394	-	621,772	-				
Deferred income tax assets - noncurrent	60,240	-	841,140	1	RETAINED EARNINGS	27,809,126	16	24,972,944
Restricted assets	149,747	-	149,447	-	OTHER EQUITY ADJUSTMENTS			
Total other assets	1,390,944	1	3,436,477	2	Unrealized gain on financial instruments	235,088	-	246,303
					Cumulative translation adjustments	3,353,938	2	(1,120,618)
					Unrecognized pension cost	(465,681)	-	(398,103)
					Treasury Stock - 233,456 thousand shares and 151,792 thousand shares as of December 31, 2011 and 2010, respectively	(4,731,741)	(3)	(3,144,312)
					Other equity adjustments, net	(1,608,396)	(1)	(4,416,730)
					Total shareholders' equity	101,169,536	59	88,556,369
TOTAL	\$171,078,607	100	\$161,626,460	100	TOTAL	\$171,078,607	100	\$161,626,460

(With Deloitte & Touche audit report dated March 13, 2012)

ADVANCED SEMICONDUCTOR ENGINEERING, INC.

STATEMENTS OF INCOME

YEARS ENDED DECEMBER 31, 2011 AND 2010

(In Thousands of New Taiwan Dollars, Except Per Share Data)

	2011		2010	
	Amount	%	Amount	%
REVENUES	\$69,975,733	101	\$68,005,684	101
LESS: SALES DISCOUNTS AND ALLOWANCES	536,568	1	666,278	1
NET REVENUES	69,439,165	100	67,339,406	100
COST OF REVENUES	51,719,001	74	50,633,615	75
GROSS PROFIT	17,720,164	26	16,705,791	25
OPERATING EXPENSES				
Research and development	3,094,997	5	2,775,607	4
Selling	771,976	1	745,295	1
General and administrative	2,994,059	4	2,823,686	5
Total operating expenses	6,861,032	10	6,344,588	10
INCOME FROM OPERATIONS	10,859,132	16	10,361,203	15
NON-OPERATING INCOME AND GAINS				
Interest income	4,642	-	10,559	-
Gain on valuation of financial assets, net	757,669	1	455,097	1
Gain on valuation of financial liabilities, net	58,962	-	-	-
Equity in earnings of equity method investments	4,497,292	6	9,918,123	15
Dividend income	607,403	1	8,279	-
Foreign exchange gain, net	-	-	457,124	1
Others	372,076	1	388,103	-
Total non-operating income and gains	6,298,044	9	11,237,285	17
NON-OPERATING EXPENSES AND LOSSES				
Interest expense	893,343	1	1,060,346	2
Loss on valuation of financial liabilities, net	-	-	872,900	1
Foreign exchange loss, net	653,041	1	-	-
Impairment loss	164,770	-	161,024	-
Others	393,434	1	471,629	1
Total non-operating expenses and losses	2,104,588	3	2,565,899	4

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INCOME BEFORE INCOME TAX	15,052,588	22	19,032,589	28
INCOME TAX EXPENSE	1,326,630	2	695,089	1
NET INCOME	\$ 13,725,958	20	\$ 18,337,500	27

(Continued)

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ADVANCED SEMICONDUCTOR ENGINEERING, INC.

STATEMENTS OF INCOME

YEARS ENDED DECEMBER 31, 2011 AND 2010

(In Thousands of New Taiwan Dollars, Except Per Share Data)

	2011		2010	
	Before Income Tax	After Income Tax	Before Income Tax	After Income Tax
EARNINGS PER SHARE (EPS)				
Basic EPS	\$2.28	\$2.08	\$2.89	\$2.78
Diluted EPS	\$2.23	\$2.03	\$2.83	\$2.73

PRO FORMA INFORMATION

Had the Company's shares held by subsidiaries been accounted for as available-for-sale financial assets rather than treasury stock (after tax):

	2011	2010
Net income for calculation of basic EPS purpose	\$13,800,118	\$19,646,568
Net income for calculation of diluted EPS purpose	\$13,800,118	\$19,502,171

EARNING PER SHARE

Basic EPS	\$2.05	\$2.91
Diluted EPS	\$2.00	\$2.86

(Concluded)

(With Deloitte & Touche audit report dated March 13, 2012)

ADVANCED SEMICONDUCTOR ENGINEERING, INC.

STATEMENTS OF CHANGES IN SHAREHOLDERS' EQUITY

YEARS ENDED DECEMBER 31, 2011 AND 2010

(In Thousands of New Taiwan Dollars)

	Capital Stock		Retained Earnings				Total	Unreal-ized Gain (loss) on Financial Instru-ment
	Common Stock	Capital Received in Advance	Capital Surplus	Legal Reserve	Special Reserve	Unappro-priated Earnings		
BALANCE, JANUARY 1, 2010	\$54,798,783	\$135,205	\$6,333,755	\$3,531,034	\$-	\$9,698,375	\$13,229,409	\$25,498
Appropriations of 2009 earnings								
Legal reserve	-	-	-	674,455	-	(674,455)	-	-
Stock dividends - 8.4%	4,615,775	-	-	-	-	(4,615,775)	(4,615,775)	-
Cash dividends - 3.6%	-	-	-	-	-	(1,978,190)	(1,978,190)	-
Issuance of common stock from capital surplus	879,195	-	(879,195)	-	-	-	-	-
Adjustment of equity method investments	-	-	(9,510)	-	-	-	-	124,744
Change in unrealized loss on available-for-sale financial assets	-	-	-	-	-	-	-	(9,290)
Disposal of treasury stock held by subsidiaries	-	-	1,271,532	-	-	-	-	-
Disposal of equity method investments	-	-	(1,472)	-	-	-	-	-
Cash dividends paid to subsidiaries	-	-	37,536	-	-	-	-	-
	-	-	-	-	-	-	-	105,351

Change in unrealized gain on cash flow hedging financial instruments									
Compensation recognized for employee stock options granted	-	-	319,147	-	-	-	-	-	-
Stock options exercised by employees	226,119	164,493	108,792	-	-	-	-	-	-
Net income in 2010	-	-	-	-	-	18,337,500	18,337,500	-	-
Cumulative translation adjustments	-	-	-	-	-	-	-	-	-
Change in net loss not recognized as pension cost	-	-	-	-	-	-	-	-	-
Acquisition of treasury stock - 37,000 thousand shares	-	-	-	-	-	-	-	-	-
BALANCE, DECEMBER 31, 2010	60,519,872	299,698	7,180,585	4,205,489	-	20,767,455	24,972,944	246,303	
Appropriations of 2010 earnings									
Legal reserve	-	-	-	1,833,750	-	(1,833,750)	-	-	-
Special reserve	-	-	-	-	1,272,417	(1,272,417)	-	-	-
Stock dividends - 11.5%	6,957,357	-	-	-	-	(6,957,357)	(6,957,357)	-	-
Cash dividends - 6.5%	-	-	-	-	-	(3,932,419)	(3,932,419)	-	-
Adjustment of equity method investments	-	-	(4,960)	-	-	-	-	-	(174,005)
Change in unrealized gain on available-for-sale financial assets	-	-	-	-	-	-	-	-	9,290
Cash dividends paid to subsidiaries	-	-	74,160	-	-	-	-	-	-
Change in unrealized gain on cash flow hedging financial	-	-	-	-	-	-	-	-	153,500

instruments

Compensation
recognized for
employee stock
options granted

- - 537,973 - - - - -

Stock options
exercised by
employees

428,403 (264,005) 424,928 - - - - -

Net income in
2011

- - - - - 13,725,958 13,725,958 -

Cumulative
translation
adjustments

- - - - - - - - -

Change in net
loss not
recognized as
pension cost

- - - - - - - - -

Acquisition of
treasury stock -
105,475 thousand
shares

- - - - - - - - -

Retirement of
treasury stock -
37,000 thousand
shares

(370,000) - (815,205) - - - - -

BALANCE,
DECEMBER 31,
2011

\$67,535,632 \$35,693 \$7,397,481 \$6,039,239 \$1,272,417 \$20,497,470 \$27,809,126 \$235,088

(With Deloitte & Touche audit report dated March 13, 2012)

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ADVANCED SEMICONDUCTOR ENGINEERING, INC.

STATEMENTS OF CASH FLOWS
YEARS ENDED DECEMBER 31, 2011 AND 2010
(In Thousands of New Taiwan Dollars)

	2011	2010
CASH FLOWS FROM OPERATING ACTIVITIES		
Net income	\$ 13,725,958	\$ 18,337,500
Adjustments to reconcile net income to net cash provided by operating activities:		
Depreciation	7,512,725	6,149,218
Amortization	388,197	344,999
Compensation cost of share-based payments granted	398,496	240,108
Provision for inventory valuation and obsolescence	123,712	76,763
Impairment loss on financial assets	93,370	41,739
Impairment loss on non-financial assets	71,400	119,285
Equity in earnings of equity method investments	(4,497,292)	(9,918,123)
Cash dividends received from equity method investments	5,791,158	2,507,350
Deferred income taxes	521,427	131,490
Foreign exchange loss (gain) on long-term bank loans	377,150	(666,000)
Others	334,909	375,212
Changes in operating assets and liabilities		
Financial assets for trading	(398,797)	(56,839)
Accounts receivable	(142,932)	(324,032)
Accounts receivable from related parties	37,163	(47,502)
Other receivables	(132,929)	(140,787)
Other receivables from related parties	(141,278)	(50,497)
Inventories	(505,456)	(900,711)
Other current assets	(88,950)	45,415
Financial liabilities for trading	(432,255)	427,574
Accounts payable	(172)	978,370
Accounts payable to related parties	(212,368)	29,559
Income tax payable	200,409	(64,517)
Accrued expenses	412,503	1,713,553
Other payables	58,833	91,993
Other payables to related parties	73,071	384,944
Other current liabilities	57,192	(127,836)
Net cash provided by operating activities	23,625,244	19,698,228
CASH FLOWS FROM INVESTING ACTIVITIES		
Acquisition of available-for-sale financial assets	(150,000)	(1,470,000)
Proceeds from disposal of available-for-sale financial assets	150,062	1,470,173
Acquisition of financial assets carried at cost	(30,914)	(23,947)
Cash received from return of capital by financial assets carried at cost	14,785	14,784
Acquisition of equity method investments	(895,405)	(13,730,817)

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Proceeds from disposal of equity method investments	-	18,000
Cash received from return of capital by equity method investments	904,587	3,169
Acquisition of property, plant and equipment	(12,121,952)	(15,210,386)
Proceeds from disposal of property, plant and equipment	939,261	216,522
Decrease (increase) in guarantee deposits	(5,097)	1,275

(Continued)

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ADVANCED SEMICONDUCTOR ENGINEERING, INC.

STATEMENTS OF CASH FLOWS
YEARS ENDED DECEMBER 31, 2011 AND 2010
(In Thousands of New Taiwan Dollars)

	2011	2010
Increase in deferred charges	\$(294,761)	\$(372,510)
Increase in restricted assets	(300)	(65,000)
Acquisition of intangible assets	(7,500)	-
Decrease (increase) in other receivables	(1,081,071)	450,000
Net cash used in investing activities	(12,578,305)	(28,698,737)
CASH FLOWS FROM FINANCING ACTIVITIES		
Increase in other payables to related parties	5,249,447	3,316,080
Proceeds from short-term borrowings	302,750	-
Proceeds from long-term bank loans	20,717,740	29,369,947
Repayments of long-term bank loans	(39,114,209)	(23,459,700)
Issuance of bonds payable	7,756,810	-
Repayments of capital lease obligations	(1,543)	(9,055)
Increase in guarantee deposits received	1,320	60
Cash dividends	(3,932,419)	(1,978,190)
Proceeds from exercise of stock options by employees	589,326	499,404
Acquisition of treasury stock	(2,772,634)	(1,185,205)
Net cash provided by (used in) financing activities	(11,203,412)	6,553,341
NET DECREASE IN CASH	(156,473)	(2,447,168)
CASH, BEGINNING OF YEAR	1,632,102	4,079,270
CASH, END OF YEAR	\$1,475,629	\$1,632,102
SUPPLEMENTAL INFORMATION		
Interest paid	\$917,468	\$1,095,413
Less: capitalized interest	43,746	43,533
Interest paid (excluding capitalized interest)	\$873,722	\$1,051,880
Income tax paid	\$608,471	\$519,421
Cash paid for acquisition of property, plant and equipment		
Acquisition of property, plant and equipment	\$13,586,160	\$14,598,373
Decrease (increase) in payables	(1,464,208)	612,013
	\$12,121,952	\$15,210,386
Cash received from disposal of property, plant and equipment		
Proceeds from disposal of property, plant and equipment	\$891,973	\$232,404

Decrease (increase) in other receivables	47,288	(15,882)
	\$939,261	\$216,522

(Continued)

ADVANCED SEMICONDUCTOR ENGINEERING, INC.

STATEMENTS OF CASH FLOWS
YEARS ENDED DECEMBER 31, 2011 AND 2010
(In Thousands of New Taiwan Dollars)

	2011	2010
Cash received from return of capital by long-term investments		
Cash received from return of capital by equity method investments	\$-	\$904,587
Decrease (increase) in other receivables from related parties	904,587	(901,418)
	\$904,587	\$3,169
Cash paid for acquisition of equity method investments		
Acquisition of equity method investments	\$1,976,476	\$13,730,817
Payments by other receivables	(1,081,071)	-
	\$895,405	\$13,730,817
FINANCING ACTIVITIES NOT AFFECTING CASH FLOWS		
Current portion of capital lease obligations (Concluded) (With Deloitte & Touche audit report dated March 13, 2012)	\$199	\$1,504

Advanced Semiconductor Engineering, Inc. and Subsidiaries

Consolidated Financial Statements as of
December 31, 2010 and 2011 and for the
Years Ended December 31, 2009, 2010 and 2011 and
Report of Independent Registered Public Accounting Firm
REPORT OF INDEPENDENT REGISTERED PUBLIC ACCOUNTING FIRM

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The Board of Directors and Shareholders
Advanced Semiconductor Engineering, Inc.

We have audited the accompanying consolidated balance sheets of Advanced Semiconductor Engineering, Inc. (a corporation incorporated under the laws of the Republic of China) and its subsidiaries (collectively, the “Company”) as of December 31, 2010 and 2011, and the related consolidated statements of income, changes in shareholders’ equity and cash flows for each of the three years in the period ended December 31, 2011, all expressed in New Taiwan dollars. These consolidated financial statements are the responsibility of the Company’s management. Our responsibility is to express an opinion on these consolidated financial statements based on our audits.

We conducted our audits in accordance with the Rules Governing the Audit of Financial Statements by Certified Public Accountants, auditing standards generally accepted in the Republic of China (“ROC”) and the Standards of the Public Company Accounting Oversight Board (United States). Those rules and standards require that we plan and perform the audit to obtain reasonable assurance about whether the consolidated financial statements are free of material misstatement. An audit includes examining, on a test basis, evidence supporting the amounts and disclosures in the consolidated financial statements. An audit also includes assessing the accounting principles used and significant estimates made by management, as well as evaluating the overall consolidated financial statement presentation. We believe that our audits provide a reasonable basis for our opinion.

In our opinion, the consolidated financial statements referred to above present fairly, in all material respects, the consolidated financial position of the Company as of December 31, 2010 and 2011, and the consolidated results of its operations and its cash flows for each of the three years in the period ended December 31, 2011, in conformity with accounting principles generally accepted in the ROC.

As discussed in Note 2 to the consolidated financial statements, the Company completed the tender offerings for the common shares of Universal Scientific Industrial Co., Ltd. (“USI”) in February and August 2010, respectively. Upon the completion of the tender offerings, USI became a subsidiary of the Company. As a result, the consolidated results of operations of USI and its subsidiaries from the date of acquisition had been included in the consolidated financial statements referred to above.

Accounting principles generally accepted in the ROC differ in certain significant respects from accounting principles generally accepted in the United States of America. Information relating to the nature and effect of such differences is presented in Note 33 to the consolidated financial statements.

Our audits also comprehended the translation of New Taiwan dollar amounts into U.S. dollar amounts and, in our opinion, such translation has been made in conformity with the basis stated in Note 2 to the consolidated financial statements. Such U.S. dollar amounts are presented solely for the convenience of the readers.

We have also audited, in accordance with the standards of the Public Company Accounting Oversight Board (United States), the Company's internal control over financial reporting as of December 31, 2011, based on the criteria established in Internal Control-Integrated Framework issued by the Committee of Sponsoring Organizations of the Treadway Commission and our report dated April 11, 2012 expressed an unqualified opinion on the Company's internal control over financial reporting.

Deloitte & Touche
Taipei, Taiwan
Republic of China

April 11, 2012

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ADVANCED SEMICONDUCTOR ENGINEERING, INC. AND SUBSIDIARIES

CONSOLIDATED BALANCE SHEETS

(Amounts in Thousands, Except Par Value)

ASSETS	December 31			LIABILITIES AND SHAREHOLDERS' EQUITY	December 31		
	2010	2011	US\$ (Note 2)		2010	2011	US\$ (Note 2)
	NT\$	NT\$			NT\$	NT\$	
CURRENT ASSETS				CURRENT LIABILITIES			
Cash	\$23,397,557	\$24,421,789	\$806,798	Short-term borrowings	\$14,154,518	\$22,965,133	\$758,676
Financial assets at fair value through profit or loss - current	1,195,273	706,755	23,348	Financial liabilities at fair value through profit or loss - current	488,818	134,274	4,436
Available-for-sale financial assets - current	338,094	48,794	1,612	Hedging derivative liabilities - current	457,494	-	-
Hedging derivative assets - current	163,670	-	-	Accounts payable	24,389,249	21,191,923	700,096
Bond investments with no active market - current	-	90,825	3,001	Income tax payable	2,739,711	2,400,592	79,306
Accounts receivable, net	33,381,917	30,475,788	1,006,799	Accrued expenses	7,843,657	8,939,719	295,333
Other receivables	1,078,537	693,016	22,894	Payable for properties	4,085,408	5,699,504	188,289
Inventories	13,170,779	13,920,757	459,886	Advance real estate receipts	41,375	47,667	1,575
Inventories related to construction business	10,125,370	16,149,498	533,515	Current portion of long-term bank loans	2,990,176	3,418,799	112,943
Deferred income tax assets - current	919,261	1,135,525	37,513	Current portion of capital lease obligations	28,838	42,161	1,393
Other current assets	1,828,467	2,488,943	82,225	Other current liabilities	2,515,258	1,922,113	63,499
Total current assets	85,598,925	90,131,690	2,977,591	Total current liabilities	59,734,502	66,761,885	2,205,546

LONG-TERM INVESTMENTS				LONG-TERM LIABILITIES			
Available-for-sale financial assets - noncurrent	310,426	173,085	5,718	Hedging derivative liabilities - noncurrent	159,279	58,279	1,925
Financial assets carried at cost - noncurrent	843,740	893,283	29,511	Bonds payable	-	10,876,538	359,318
Bond investments with no active market - noncurrent	87,420	-	-	Long-term bank loans	52,363,718	39,266,414	1,297,206
Equity method investments	1,158,498	1,154,360	38,135				